

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	09/900,398	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 14:23
L2	14	("5268315" "5812364" "5920775" "5946567" "5985731" "6083805" "6110772" "6124165" "6156640" "6174766" "6500763").PN. OR ("6576526"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/07 14:23
L3	1	("6656850").PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 14:23
L4	8	("4450048" "5479316" "5514247" "5708559" "5843827" "5865900" "5872062" "5939750").PN. OR ("6656850").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/06/07 14:23
L5	22	2 4	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 14:23
L6	22	5 and @ad<"20021224"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 14:24
S1	3	("5406447" "6468858" "6597068").PN.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:11
S2	1314	MIM with capacitor	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:11
S3	39134	RIE "reactive ion etching"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:11
S4	155085	nitride	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:11
S5	25335	titanium adj nitride	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:12
S6	1642	AlCu	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:12
S7	3803	"CHF"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:12

S8	0	S2 and S3 and S4 and S5 and S6 and S7	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:12
S9	22	S2 and S3 and S4 and S5 and S6	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:12
S10	103	S2 and S3 and S4 and S5	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:12
S11	74	S10 and @ad<"20021224"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08
S12	3842	(438/253,396,712).CCLS.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:13
S13	3448	S12 and @ad<"20021224"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 14:24
S14	2	jo-bo-yeoun.in.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:13
S15	10139	"CHF.sub.3"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:30
S16	37	S2 and S3 and S15	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08
S17	25	S16 and @ad<"20021224"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 10:30
S18	2	("2003/0008467").URPN.	USPAT	OR	OFF	2005/06/07 13:07
S19	39134	RIE "reactive ion etching"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08
S20	10139	"CHF.sub.3"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08
S21	848	capacitor? and S19 and S20	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08
S22	765	S21 and @ad<"20021224"	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08
S23	532	S22 and "438"/\$3.ccls.	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:08

S24	504	S23 and nitride	US-PGPUB; USPAT; IBM_TDB	OR	OFF	2005/06/07 13:09
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.(FILE 'HOME' ENTERED AT 14:44:04 ON 07 JUN 2005)

FILE 'INSPEC, CAPLUS' ENTERED AT 14:44:11 ON 07 JUN 2005

L1	1018 S (MIM OR MOM) (W) CAPACITOR?
L2	16784 S RIE OR REACTIVE ION ETCHING
L3	12 S L1 AND L2
L4	118819 S CAPACITOR
L5	450 S L2 AND L4